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SPECIFICATION

TO ALL WHOM IT MAY CONCERN:

BE IT KNOWN THAT WE, Masaru Ishiwa, a citizen of Japan residing at Kawasaki, Japan and Susumu Okazaki, a citizen of Japan residing at Kawasaki, Japan have invented certain new and useful improvements in

LIQUID-CRYSTAL DISPLAY UNIT HAVING A THIRD BOARD HAVING AT LEAST ONE OF A SIGNAL-LINE DRIVE CIRCUIT AND A SCANNING-LINE DRIVE CIRCUIT

of which the following is a specification : -

09/930048

TITLE OF THE INVENTION

LIQUID-CRYSTAL DISPLAY UNIT HAVING A THIRD BOARD HAVING AT LEAST ONE OF A SIGNAL-LINE DRIVE CIRCUIT AND A SCANNING-LINE DRIVE CIRCUIT

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BACKGROUND OF THE INVENTION

1. Field of the Invention

The present invention generally relates to a liquid-crystal display unit, and more particularly, to a liquid-crystal display unit displaying an image on a liquid-crystal panel.

2. Description of the Related Art
FIG.1 is an illustration showing a
structure of a conventional liquid-crystal display
unit. As shown in FIG.1, a liquid-crystal display
unit 11 comprises a pixel electrode board 1, thinfilm transistors (TFTs) 2, signal lines 3, scanning
lines 4, a common electrode board 5, a common
electrode 6, a liquid-crystal layer 7, a signal-line
drive circuit 9, a scanning-line drive circuit 10,
and pixel electrodes 23. The TFTs 2, the signal
lines 3, the scanning lines 4, the pixel electrodes
23, the common electrode 6, the liquid-crystal layer
7 provided between the pixel electrodes 23 and the
common electrode 6, compose a liquid-crystal panel.

pixel matrix formed on the pixel electrode board 1 shown in FIG.1. As shown in FIG.1 and FIG.2, the TFTs 2, the pixel electrodes 23 each connected to the TFT 2, the signal lines 3, the scanning lines 4, the signal-line drive circuit 9 driving the signal lines 3, and the scanning-line drive circuit 10 driving the scanning lines 4 are formed on the pixel electrode board 1. The common electrode 6 is formed on the common electrode board 5.

Also, as shown in FIG.2, the pixel electrodes 23 are formed in the form of a matrix on

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The signal line 3 the pixel electrode board 1. supplies an image signal to the pixel electrode 23. The scanning line 4 transmits a control signal to a gate of the TFT 2, the control signal turning on/off the TFT 2 which is connected to the pixel electrode 23 so as to regulate writing of data to each pixel.

It is noted that a unit like the liquidcrystal display unit 11 that drives the signal lines 3 and the scanning lines 4 so as to display an image by means of liquid crystal via the pixel electrodes 23 formed in the form of a matrix is referred to as an "active matrix liquid-crystal display unit".

On the other hand, there is also another conventional liquid-crystal display unit, as a second type of the active matrix liquid-crystal 15 display unit, comprising a printed circuit board formed of glass epoxy resin, the printed circuit board having the signal-line drive circuit 9 and the scanning-line drive circuit 10, and a pixel electrode board formed of glass, the pixel electrode 20 board having the pixel electrodes 23, the signal lines 3 and the scanning lines 4, wherein the printed circuit board and the pixel electrode board are connected to each other by a flexible cable.

However, the conventional liquid-crystal 25 display unit 11 as the active matrix liquid-crystal display unit shown in FIG.1, especially a liquidcrystal display unit of, so to speak, an allperipheral-circuits-in-one type having an operating semiconductor layer of a TFT formed of 30 polycrystalline silicon (polysilicon: p-Si), is provided with more than multimillion pixel electrodes 23 and a multitude of circuits such as the signal-line drive circuit 9 and the scanningline drive circuit 10 both consisting of numerous 35 circuit components, all of which electrodes and circuits are formed on the pixel electrode board 1;

-3therefore, such a conventional liquid-crystal manufactured inferiorly. 5

display unit incurs a high possibility that at least one of those electrodes and circuits thereof be Then, when even one of those elements is actually manufactured inferiorly, the pixel electrode board 1 falls out of use even though all other elements function normally; thus, the conventional liquid-crystal display units suffers a problematically poor yield rate.

On the other hand, the above-mentioned second type of the active matrix liquid-crystal display unit is difficult to design because of the structure thereof in which the printed circuit board and the pixel electrode board having different coefficients of thermal expansion are connected to each other by a flexible cable. Furthermore, the above-mentioned second type of the active matrix liquid-crystal display unit provides little reliability in operation since conditions in the connection part vary depending on the operating temperatures.

SUMMARY OF THE INVENTION

It is a general object of the present invention to provide an improved and useful liquid-25 crystal display unit and a manufacturing method thereof in which the above-mentioned problems are eliminated.

A more specific object of the present invention is to provide a liquid-crystal display 30 unit which can have an increased yield rate and can provide enhanced reliability in operation, as well as a manufacturing method thereof.

In order to achieve the above-mentioned objects, there is provided according to one aspect 35 of the present invention a liquid-crystal display unit comprising:

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a first board having a signal line, a scanning line and a pixel electrode;

a second board having a common electrode, the second board opposing the first board;

a liquid-crystal layer provided between the first board and the second board; and

a third board having at least one of a signal-line driver driving the signal line and a scanning-line driver driving the scanning line, the

third board being separate from the first board and 10. the second board.

According to the present invention, the third board having at least one of the signal-line driver and the scanning-line driver can be formed separately from the first board and the second board. Therefore, the first board, the second board and the third board can be manufactured without being influenced by each other.

Other objects, features and advantages of the present invention will become more apparent from 20 the following detailed description when read in conjunction with the accompanying drawings.

BRIEF DESCRIPTION OF THE DRAWINGS

FIG.1 is an illustration showing a 25 structure of a conventional liquid-crystal display unit;

FIG.2 is a plan view showing a layout of a pixel matrix formed on a pixel electrode board shown in FIG.1: 30

FIG.3 is an illustration showing a structure of a liquid-crystal display unit according to an embodiment of the present invention;

FIG.4 is an illustration for explaining processes of manufacturing a third board and a pixel 35 electrode board shown in FIG.3;

FIG.5 is an illustration for explaining a

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first manner of connecting the pixel electrode board and the third board shown in FIG.3;

FIG.6 is an illustration for explaining a second manner of connecting the pixel electrode board and the third board shown in FIG.3;

FIG.7 is a magnified view of a first example of a connection part shown in FIG.6; and FIG.8 is a magnified view of a second example of the connection part shown in FIG.6.

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DETAILED DESCRIPTION OF THE PREFERRED EMBODIMENTS

A description will now be given, with reference to the drawings, of embodiments according to the present invention. Elements in the drawings that are identical or equivalent are referenced by the same characters.

FIG.3 is an illustration showing a structure of a liquid-crystal display unit 21 according to an embodiment of the present invention. The liquid-crystal display unit 21 shown in FIG.3 comprises the pixel electrode board (a first board)

comprises the pixel electrode board (a first board)

1, the thin-film transistors (TFTs) 2, the signal

lines 3, the scanning lines 4, the common electrode

board (a second board) 5, the common electrode 6,

the liquid-crystal layer 7, the signal-line drive circuit 9, the scanning-line drive circuit 10, a third board 12, a connecting portion 18, and the pixel electrodes 23. The TFTs 2, the signal lines 3, the scanning lines 4, the pixel electrodes 23, the

ommon electrode 6, the liquid-crystal layer 7 provided between the pixel electrodes 23 and the common electrode 6, compose a liquid-crystal panel.

Unlike the conventional liquid-crystal display unit 11 shown in FIG.1, the TFTs 2, the pixel electrodes 23 each connected to the TFT 2, the signal lines 3, the scanning lines 4, and the scanning-line drive circuit 10 driving the scanning

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lines 4 are formed on the pixel electrode board 1, and the common electrode 6 is formed on the common electrode board 5; the signal-line drive circuit 9 driving the signal lines 3 is formed on the third board 12 separated physically from the pixel electrode board 1 and the common electrode board 5, and is connected to the signal lines 3 formed on the pixel electrode board 1 by the connecting portion 18.

The pixel electrodes 23 are formed in the

form of a matrix on the pixel electrode board 1.

The signal line 3 supplies an image signal to the

pixel electrode 23. The scanning line 4 transmits a

control signal to a gate of the TFT 2, the control

signal turning on/off the TFT 2 which is connected

to the pixel electrode 23 so as to regulate writing

of data to each pixel.

Besides, the TFTs (thin-film transistors) 2 and transistors composing the signal-line drive circuit 9 and the scanning-line drive circuit 10 each have a semiconductor layer formed of polysilicon.

FIG.4 is an illustration for explaining processes of manufacturing the third board 12 and the pixel electrode board 1 shown in FIG.3. above-mentioned structure, in a case where the third board 12 and the pixel electrode board 1 are formed of a same material, the signal-line drive circuit 9, the signal lines 3, the scanning lines 4, the TFTs 2, and the pixel electrodes 23 each connected to the TFT 2, can be formed, for example, on a same glass substrate 13 in a same process, as shown in FIG.4, and then the glass substrate 13 can be severed along severing lines 17 into a plurality of the pixel electrode boards 1 each having the signal lines 3, the scanning lines 4, the TFTs 2 and the pixel electrodes 23 and a plurality of the third boards 12 each having the signal-line drive circuit 9,

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simultaneously in a same process.

Therefore, in this case, manufacturing costs of the pixel electrode board 1 and the third board 12 can be reduced so as to provide the liquid-crystal display unit 21 at a low cost.

Hereinbelow, a description will be given of manners of connecting the pixel electrode board 1 and the third board 12 shown in FIG.3. First, as shown in FIG.5, the pixel electrode board 1 and the third board 12 can be connected to each other by laying flexible cables 14 therebetween. In this manner, the flexible cables 14 are flexible and electrically conductive, and specifically, the flexible cables 14 connect the signal-line drive circuit 9 formed on the third board 12 to the signal lines 3 formed on the pixel electrode board 1.

Also, as shown in FIG.6, the pixel electrode board 1 and the third board 12 can be connected to each other by providing the common electrode board 5 and the third board 12 on the pixel electrode board 1 and connecting the pixel electrode board 1 and the third board 12 in a connection part 19. FIG.7 and FIG.8 are magnified views of the connection part 19. Specifically, as shown in FIG.7, the third board 12 and the pixel electrode board 1 can be connected to each other by Also, as shown in FIG.8, the a wire-bonding 15. third board 12 and the pixel electrode board 1 can be connected to each other by providing a flip-chip The flip-chip bonding 16 bonding 16 therebetween. can be formed of such a material as a solder bump, an anisotropic conductive resin, or an anisotropic conductive rubber.

As described above, in the liquid-crystal
35 display unit 21 according to the present embodiment,
the signal-line drive circuit 9 is formed on the
third board 12 that is made of the same material as

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-8manufactured normally. Accordingly, the pixel electrode board 1, 10 yield rate. 15 20

the pixel electrode board 1 and is separated from the pixel electrode board 1 and the common electrode board 5. Therefore, even if the pixel electrode board 1 is manufactured inferiorly, the third board 12 is still usable, as long as the third board 12 is Also, conversely, even if the third board 12 is manufactured inferiorly, the pixel electrode board 1 is still usable, as long as the pixel electrode board 1 is manufactured normally.

the common electrode board 5 and the third board 12 can be manufactured without being influenced by each other being manufactured inferiorly; thus the liquid-crystal display unit 21 can have an increased

In addition, the pixel electrode board 1 and the third board 12 are formed of the same material, as described above, so that electrical connection is made between the boards having an equal coefficient of thermal expansion. Therefore, the liquid-crystal display unit 21 can provide an enhanced reliability in operation at varying temperatures.

It should be noted that, although the above-described embodiment discloses the liquid-25 crystal display unit 21 having only the signal-line drive circuit 9 formed on the third board 12, forming the scanning-line drive circuit 10 in place of the signal-line drive circuit 9 on the third board 12 can provide the same effects and advantages. 30 Further, forming the signal-line drive circuit 9 and the scanning-line drive circuit 10 unitarily or separately on the third board 12 can also provide the same effects and advantages.

The present invention is not limited to the specifically disclosed embodiments, and variations and modifications may be made without

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departing from the scope of the present invention.

The present application is based on

Japanese priority application No. 2000-391366 filed
on December 22, 2000, the entire contents of which
are hereby incorporated by reference.